



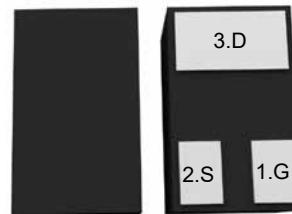
PJM01P20KDC

P-Channel Enhancement Mode Power MOSFET

Features

- Low gate charge and $R_{DS(ON)}$
- ESD protected(HBM) up to 2KV
- $V_{DS} = -20V, I_D = -0.65A$
- $R_{DS(on)} < 850m\Omega @ V_{GS} = -4.5V$

DFN1x0.6-3L



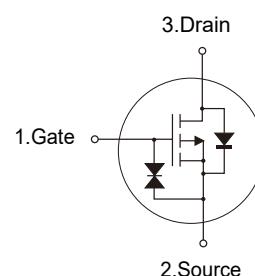
1. Gate 2. Source 3. Drain

Applications

- Load switch and in PWM applications
- Power management

Marking Code: JP

Schematic Diagram



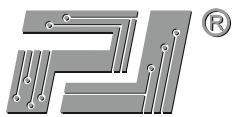
Absolute Maximum Ratings

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$-V_{DS}$	20	V
Gate-Source Voltage	$-V_{GS}$	± 12	V
Drain Current-Continuous	$-I_D$	0.65	A
Drain Current-Pulsed ^{Note1}	$-I_{DM}$	2	A
Maximum Power Dissipation	P_D	0.35	W
Junction Temperature	T_J	150	°C
Storage Temperature Range	T_{STG}	-55 to +150	°C

Thermal Characteristics

Thermal Resistance, Junction-to-Ambient ^{Note2}	R_{eJA}	357	°C/W
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Electrical Characteristics

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	-V _{(BR)DSS}	V _{GS} =0V, I _D =-250μA	20	--	--	V
Zero Gate Voltage Drain Current	-I _{DSS}	V _{DS} =-20V, V _{GS} =0V	--	--	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±10V, V _{DS} =0V	--	--	±10	μA
Gate Threshold Voltage ^{Note3}	-V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	0.35	0.62	1.2	V
Drain-Source On-Resistance ^{Note3}	R _{DS(on)}	V _{GS} =-4.5V, I _D =-0.5A	--	580	850	mΩ
		V _{GS} =-2.5V, I _D =-0.3A	--	855	1200	mΩ
Forward Transconductance ^{Note3}	g _{FS}	V _{DS} =-5V, I _D =-0.3A	--	2	--	S
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =-10V, V _{GS} =0V, f=1MHz	--	71	--	pF
Output Capacitance	C _{oss}		--	20	--	pF
Reverse Transfer Capacitance	C _{rss}		--	15	--	pF
Switching Characteristics						
Turn-on Delay Time	t _{d(on)}	V _{DD} =-10V, R _L =2.5Ω, V _{GS} =-4.5V, R _{GEN} =3Ω	--	4	--	nS
Turn-on Rise Time	t _r		--	19	--	nS
Turn-off Delay Time	t _{d(off)}		--	16	--	nS
Turn-off Fall Time	t _f		--	25	--	nS
Total Gate Charge	Q _g	V _{DS} =-10V, I _D =-0.5A, V _{GS} =-4.5V	--	1.24	--	nC
Gate-Source Charge	Q _{gs}		--	0.37	--	nC
Gate-Drain Charge	Q _{gd}		--	0.27	--	nC
Source-Drain Diode Characteristics						
Diode Forward Voltage ^{Note3}	-V _{SD}	V _{GS} =0V, I _S =-0.65A	--	--	1.2	V
Diode Forward Current ^{Note2}	-I _S		--	--	0.65	A

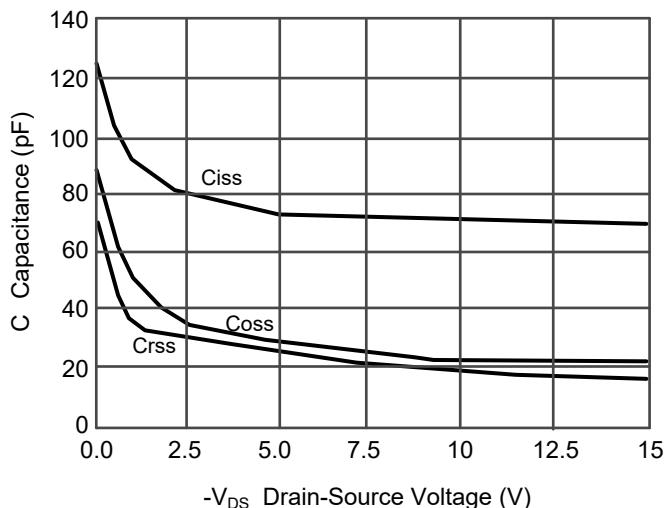
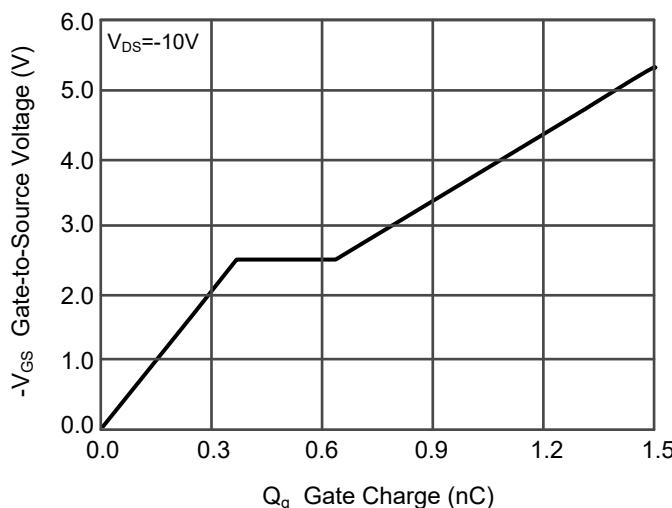
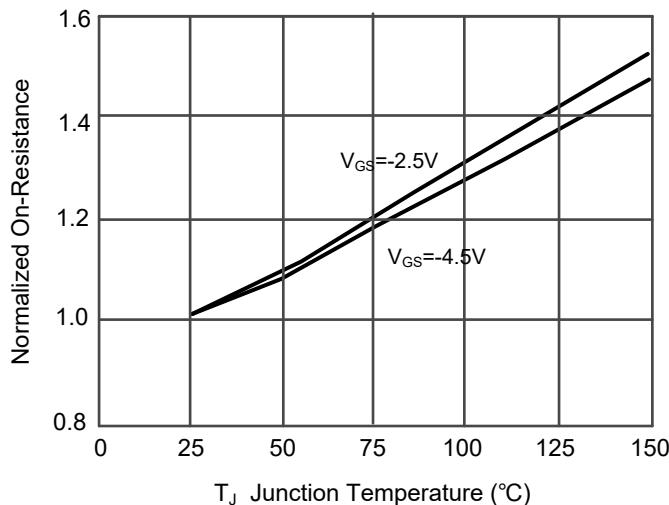
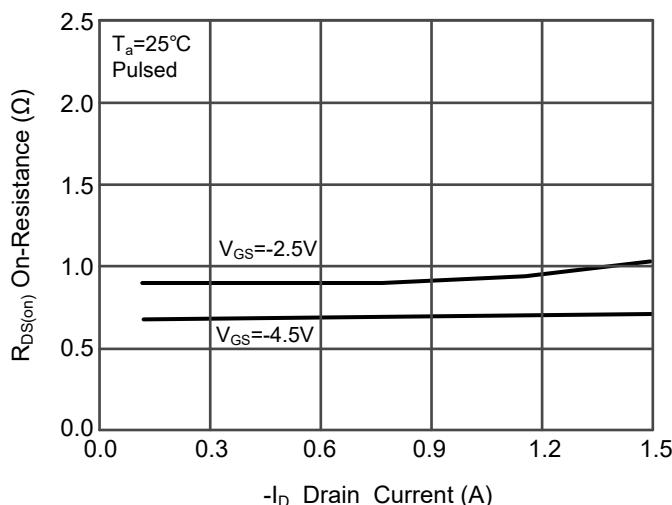
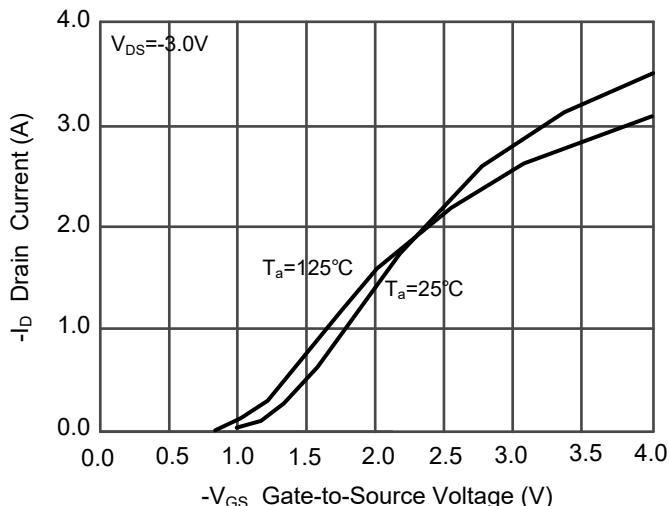
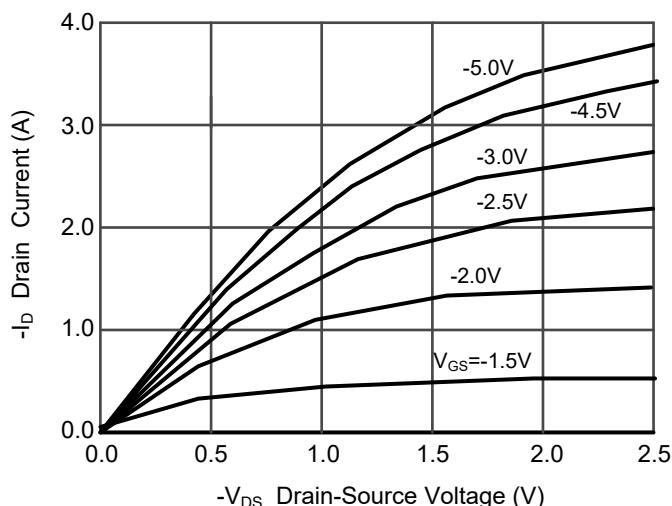
Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

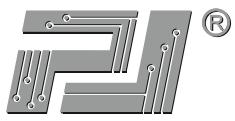
2. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.

3. Pulse Test: Pulse width≤300μs, duty cycle≤2%.



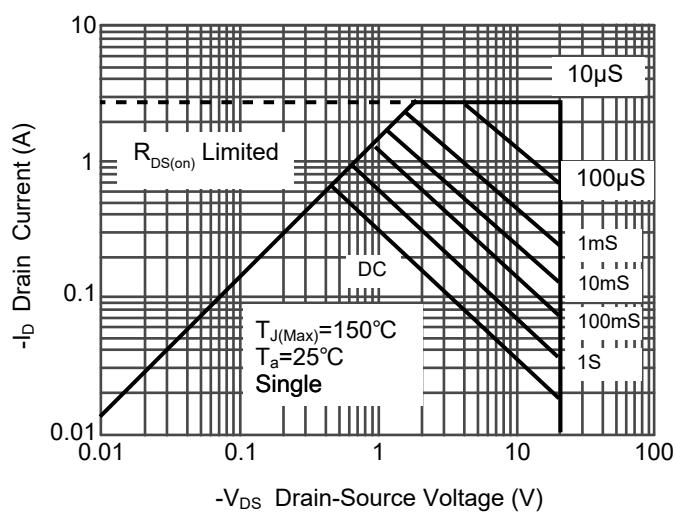
Typical Characteristic Curves





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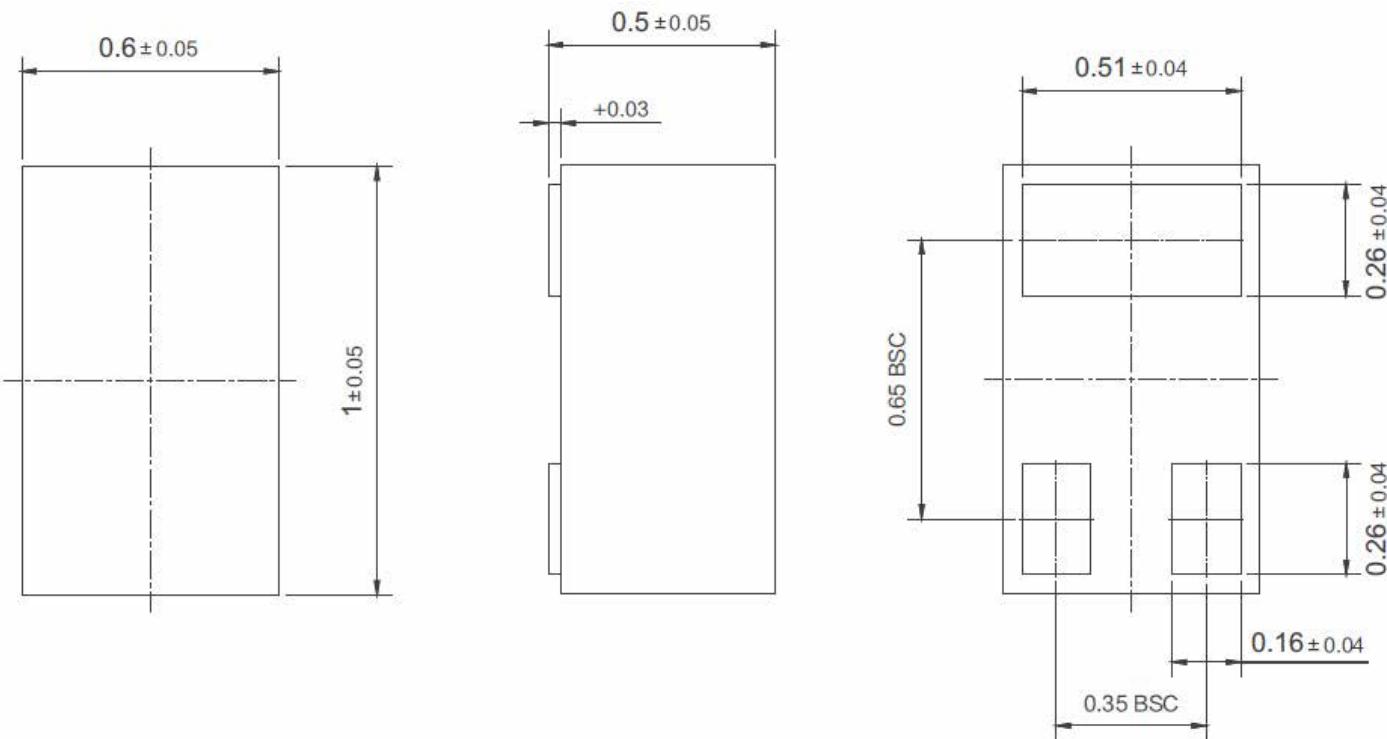
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Package Outline

DFN1x0.6-3L-0009

Dimensions in mm



Ordering Information

Device	Package	Shipping
PJM01P20KDC	DFN1x0.6-3L	10,000PCS/Reel&7inches